



Product Change Notification

Change Notification #: 118670-00
Change Title: Select Intel® NUC Rugged Chassis Element
CMCR1ABB
PCN 118670-00, Label,
Label Updates
Date of Publication: November 12, 2021

Key Characteristics of the Change:
 Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	November 27, 2021
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Description of Change to the Customer:

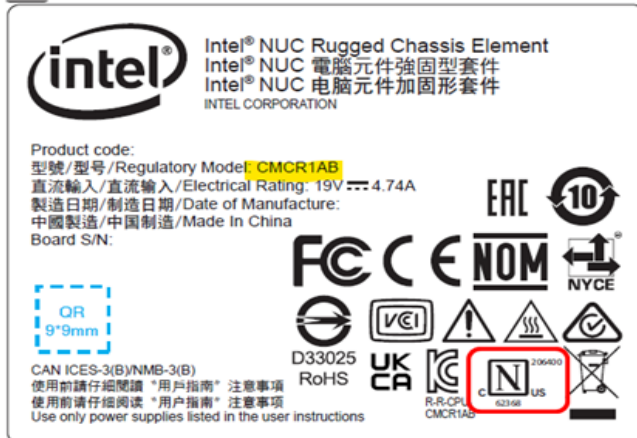
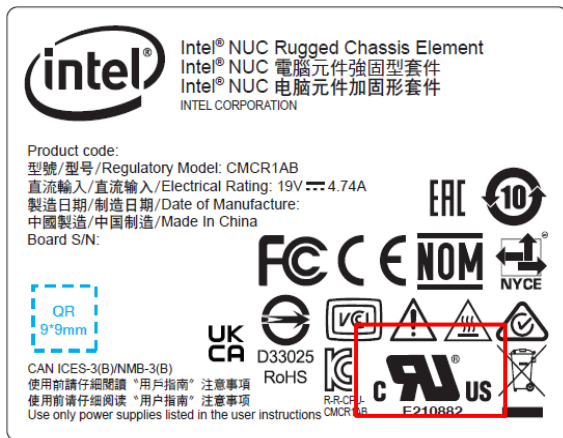
- The Intel SKUs listed in the products affected table will have the following changes.

- Change CB logo on rating label from UL to NRTL due to Lab convert from UL CB to Nemko NRTL CB in AB ver.B Sku.

Rating label with NTRL logo

Before:

After



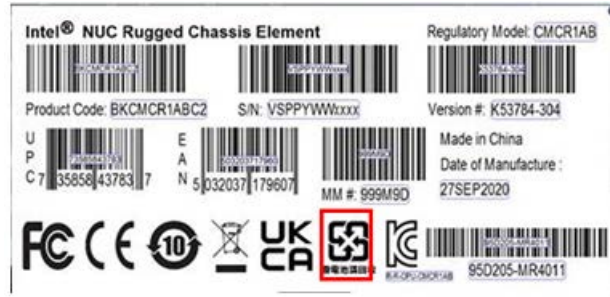
- Added Taiwan battery recycling mark on box label of AB ver.B sku.

Box label with adding Taiwan battery recycling mark:

Before



After



- Inner color of Bottom cover changes due to improving inner surface process.

Inner bottom cover process improvement:

Before



After



- Turnkey part implements on EMI gasket substitute and low VOC painting power button.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Post Change SA
Intel® NUC Rugged Chassis Element CMCR1ABB, no cord, 2 pack	BKCMCR1ABB	999M96	K53778-205	K53778-206
Intel® NUC Rugged Chassis Element CMCR1ABB, US cord, 2 pack	BKCMCR1ABB1	999M97	K53778-205	K53778-206
Intel® NUC Rugged Chassis Element CMCR1ABB, EU cord, 2 pack	BKCMCR1ABB2	999M98	K53778-205	K53778-206

PCN Revision History:

Date of Revision:
November 12, 2021

Revision Number:
00

Reason:
Originally Published PCN



Product Change Notification

118670-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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